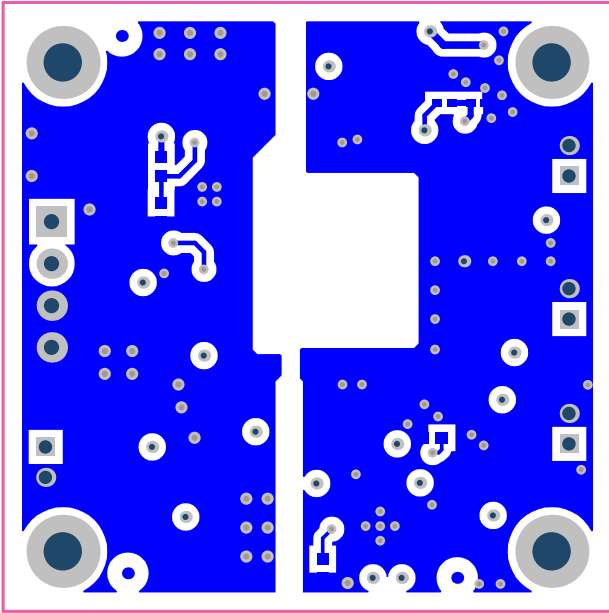
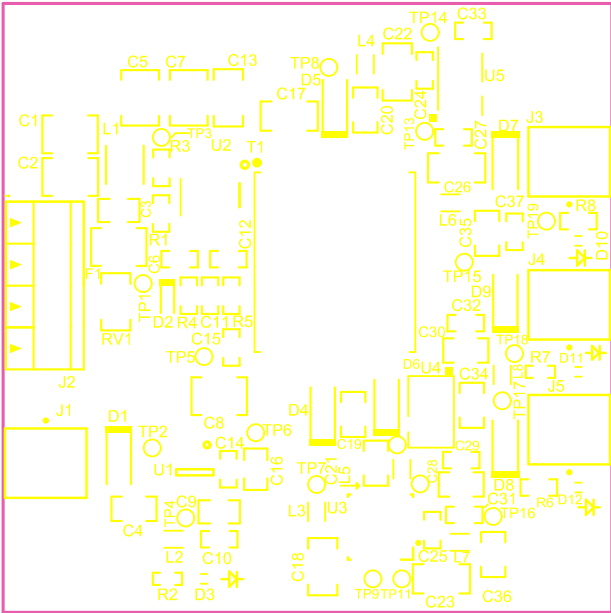


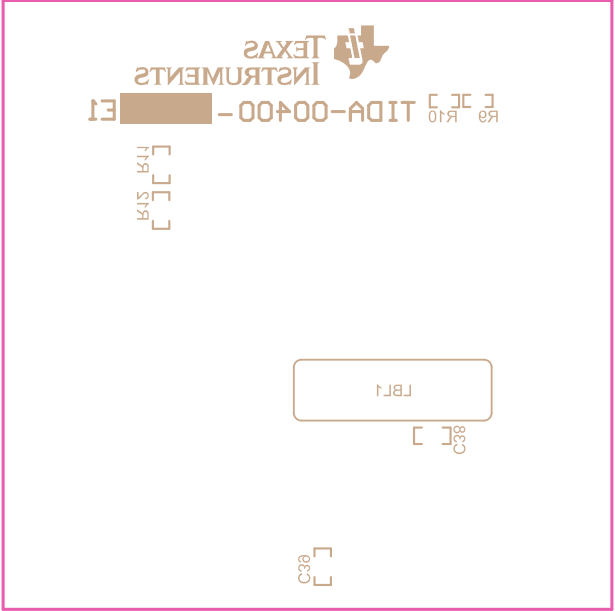
MopBayerOutline



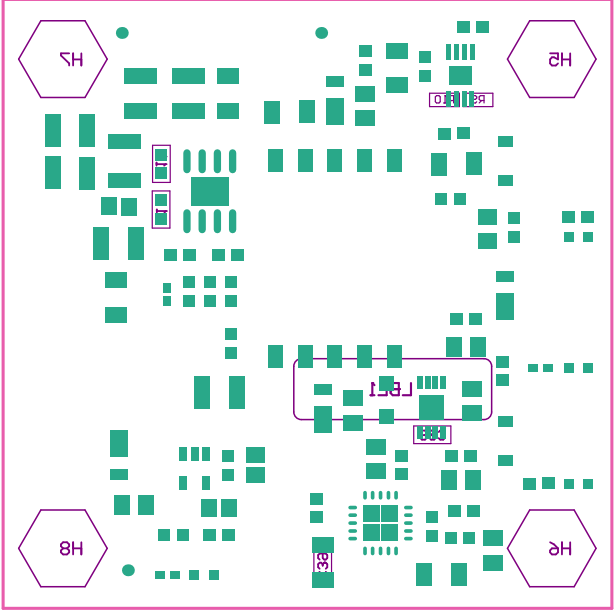
Bot Bomr Lagerline



MbpBoard1Outline

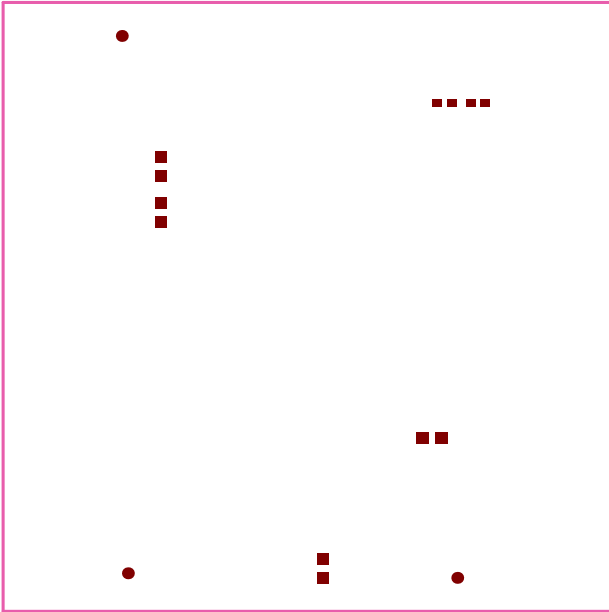


▶ Board Outline

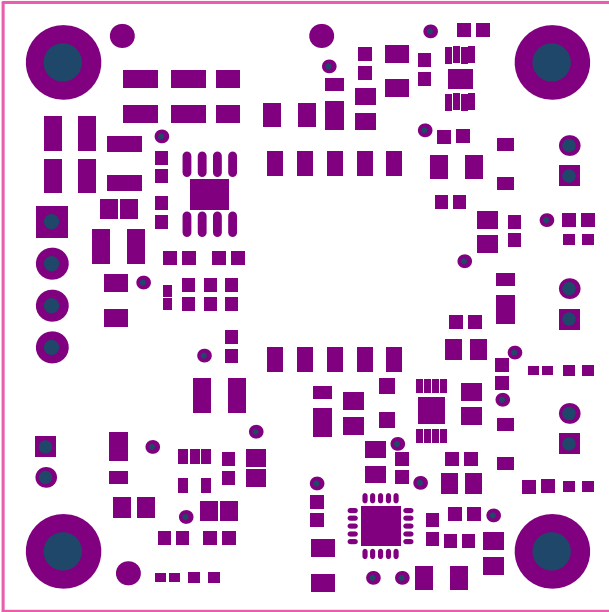


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT [No Variations]

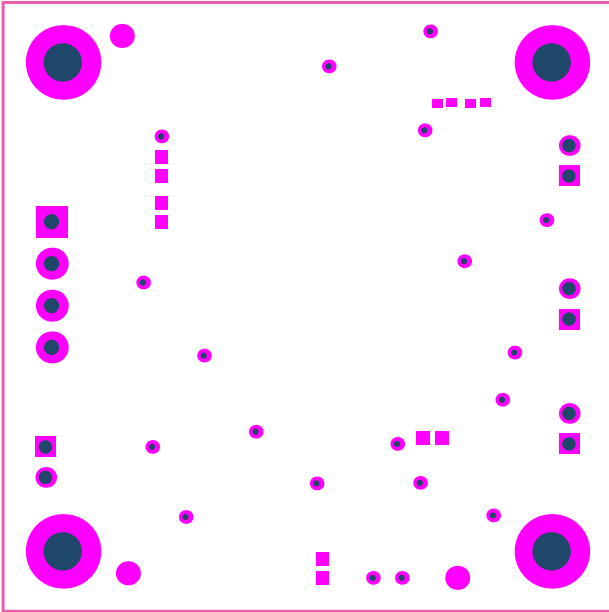
PCB VIEWED FROM BOTTOM SIDE		BOARD #: TIDA-00400	REV: E1	SVN REV: Not In VersionControl
PLOT NAME = Top Paste Mask Print		GENERATED : 3/10/2015 2:10:00 PM		
IGNORE ->		Top Paste Outline		
TEXAS INSTRUMENTS				



Bottom Pasteline

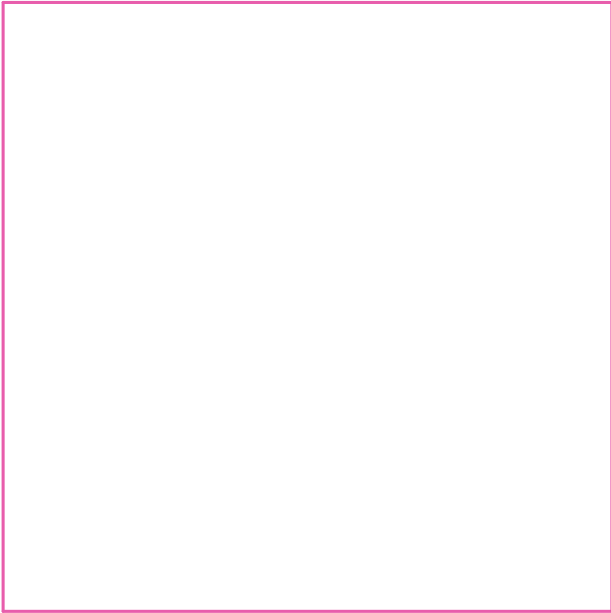


Top Side Outline



Et Board Solidine





M2 Board Dimensions

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